STT5N2VH5



N-channel 20 V, 0.025 Ω typ., 5 A STripFET™ V Power MOSFET in a SOT23-6L package

Datasheet — production data

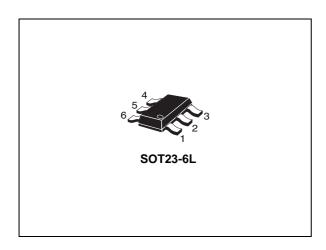
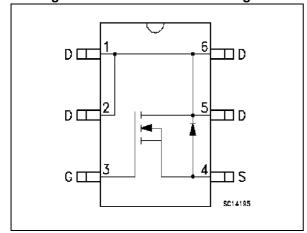


Figure 1. Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	I _D	P _{TOT}
STT5N2VH5	20 V	0.04 Ω (V _{GS} =2.5 V)	5 A	1.6 W

- Very low profile package
- · Conduction losses reduced
- Switching losses reduced
- 2.5 V gate drive
- · Very low threshold device

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using STMicroelectronics' STripFET™V technology. The device has been optimized to achieve very low on-state resistance, contributing to a FOM that is among the best in its class.

Table 1. Device summary

Order code	Marking	Packages	Packaging	
STT5N2VH5	STD1	SOT23-6L	Tape and reel	

Contents STT5N2VH5

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STT5N2VH5 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	20	٧
V_{GS}	Gate-source voltage	± 8	V
I _D ⁽¹⁾	Drain current (continuous) at T _{pcb} = 25 °C	5	Α
I _D ⁽¹⁾	Drain current (continuous) at T _{pcb} = 100 °C	3.1	Α
I _{DM} ⁽¹⁾⁽²⁾	Drain current (pulsed)	20	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _{pcb} = 25 °C		W
T _{stg}	Storage temperature	- 55 to 150	°C
T _j	Max. operating junction temperature	- 55 to 150 perating junction temperature	

^{1.} This value is rated according to R_{thj-pcb}

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb max	78	°C/W

^{1.} When mounted on 1 inch² FR-4, 2 Oz Cu, t< 10 sec.

^{2.} Pulse width is limited by safe operating area

Electrical characteristics STT5N2VH5

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	20			V
1	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 20 V			1	μΑ
DSS		V _{DS} = 20 V, T _C =125 °C			10	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±8 V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	0.7			٧
I Booken I state to the state of the state o	Static drain-source	$V_{GS} = 4.5 \text{ V}, I_D = 2 \text{ A}$		0.025	0.03	Ω
	on-resistance	$V_{GS} = 2.5 \text{ V}, I_D = 2 \text{ A}$		0.031	0.04	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	367	-	pF
C _{oss}	Output capacitance	$V_{DS} = 16 \text{ V, f} = 1 \text{ MHz,}$	-	92	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	16	-	pF
Q_g	Total gate charge	V _{DD} = 16 V, I _D = 2 A,	-	4.6	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 4.5 V	-	0.9	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14)	-	1	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Voltage delay time		-	4.8	-	ns
t _{r (V)}	Voltage rise time	V_{DD} = 16 V, I_D = 2 A, R_G = 4.7 Ω , V_{GS} = 4.5 V (see <i>Figure 15</i> and <i>Figure 18</i>)	-	14.4	-	ns
t _{d (off)}	Current fall time		-	17	-	ns
t _f	Crossing time		-	4	-	ns



Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		5	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		20	Α
V _{SD} (2)	Forward on voltage	$I_{SD} = 2 A, V_{GS} = 0$	-		1.1	٧
t _{rr}	Reverse recovery time	$I_{SD} = 2 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$	-	10		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 16 V, T _j = 150 °C	-	24		nC
I _{RRM}	Reverse recovery current	(see Figure 18)	1	4.8		Α

^{1.} Pulse width limited by safe operating area.

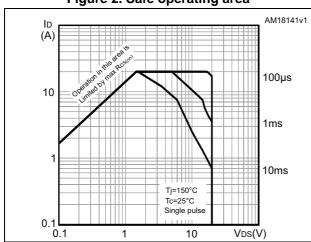
^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STT5N2VH5

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance



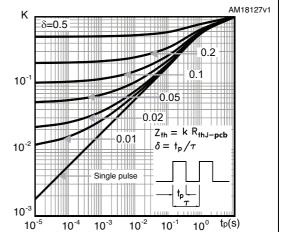
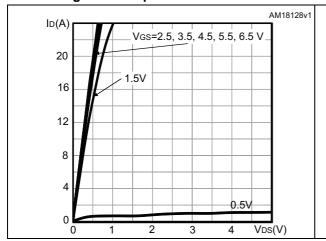


Figure 4. Output characteristics

Figure 5. Transfer characteristics



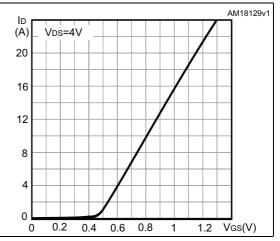
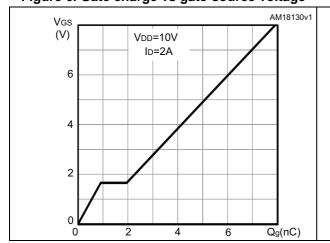
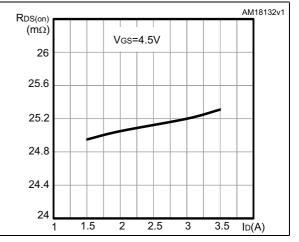


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



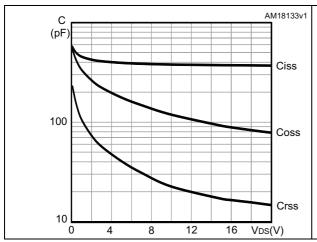


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Figure 8. Capacitance variations

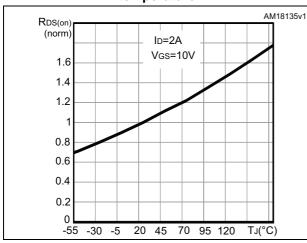
Figure 9. Normalized gate threshold voltage vs temperature



VGS(th) (norm)
1.2
1
0.8
0.6
0.4
0.2
0
-55 -30 -5 20 45 70 95 120 TJ(°C)

Figure 10. Normalized on-resistance vs temperature

Figure 11. Normalized $V_{(BR)DSS}$ vs temperature



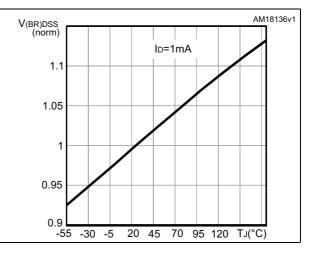
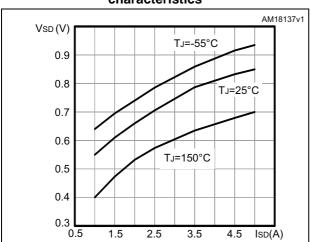


Figure 12. Source-drain diode forward characteristics



Test circuits STT5N2VH5

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

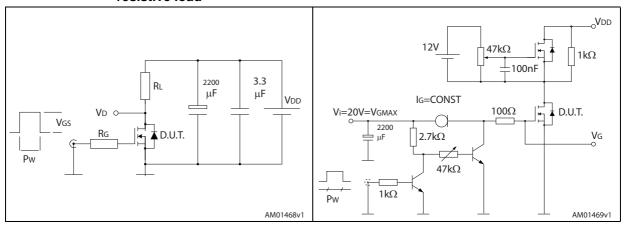


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

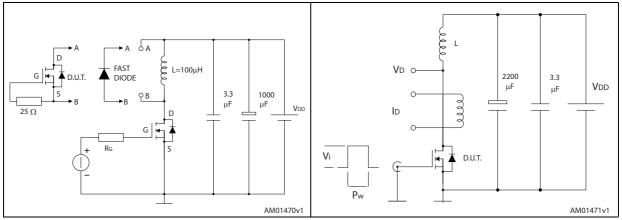
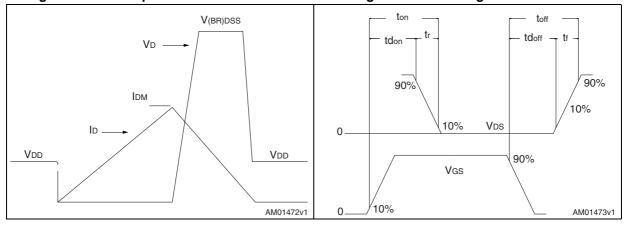


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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4 Package mechanical data

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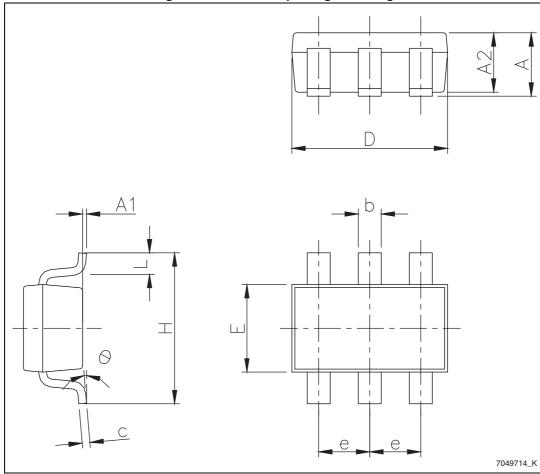


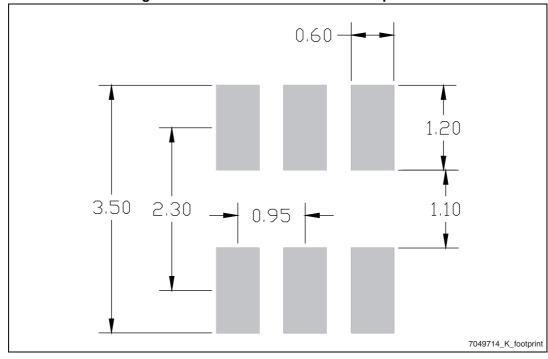
Figure 19. SOT23-6L package drawing

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Table 8. SOT23-6L package mechanical data

Dim.		mm	
Diiii.	Min.	Тур.	Max.
А			1.25
A1	0.00		0.15
A2	1.00	1.10	1.20
b	0.36		0.50
С	0.14		0.20
D	2.826	2.926	3.026
Е	1.526	1.626	1.726
е	0.90	0.95	1.00
Н	2.60	2.80	3.00
L	0.35	0.45	0.60
θ	0 °C		8 °C

Figure 20. SOT23-6L recommended footprint^(a)



a. All dimensions are in millimeters



Revision history STT5N2VH5

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
20-Mar-2014	1	First release. Part number previously included in datasheet DocID023799

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